



Power Resistor for Mounting onto a Heatsink Thick Film Technology

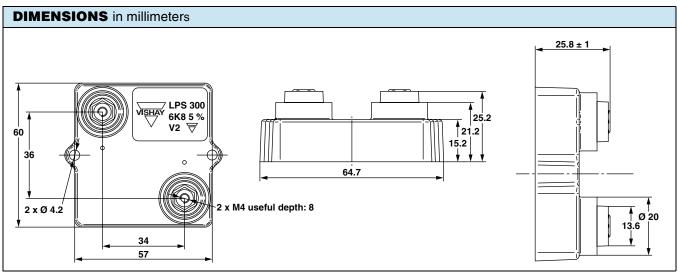


FEATURES

- 300 W at 85 °C bottom case temperature



- Non inductive
- Easy mounting
- Low thermal radiation of the case
- Compliant to RoHS directive 2002/95/EC



Note

• Tolerances unless stated: ± 0.2 mm

MECHANICAL SPECIFICATIONS

Mechanical Protection Insulated case UL 94 V-0

Resistive Element Thick film
Substrate Alumina
End Connections Screws M4

Tightening Torque

 $\begin{array}{lll} \textbf{- On Connections} & 2 \text{ Nm} \\ \textbf{- On Heatsink} & 2 \text{ Nm} \\ \textbf{Maximum Torque} & 2.5 \text{ Nm} \\ \textbf{Weight} & 83 \text{ g} \pm 10 \text{ \%} \\ \end{array}$

ENVIRONMENTAL SPECIFICATIONS

Temperature Range - 55 °C to 120 °C **Climatic Category** 55/120/56

ELECTRICAL SPECIFICATIONS				
Resistance Range	$0.3~\Omega$ to $900~\text{k}\Omega$			
Tolerances (Standard)	± 1 % to ± 10 %			
Power Rating and Thermal Resistance	300 W at + 85 °C bottom case temperature R _{TH (j - c)} : 0.112 °C/W			
Temperature Coefficient - 55 °C/120 °C IEC 60115-1 Standard	R ≤ 1 <i>U</i> : ± 500 ppm/°C 1 <i>U</i> < R ≤ 10 <i>U</i> : ± 300 ppm/°C 10 <i>U</i> < R: ± 150 ppm/°C			
Limiting Element Voltage U _L	5 kV			
Dielectric Strength IEC 60115-1, 1 min, 10 mA max.	7 kV _{RMS} or 12 kV _{RMS}			
Insulation Resistance	$\geq 10^4 \ \text{M}\Omega$			
Inductance	≤ 0.1 μH			
Critical Resistance	83.33 kΩ			

Vishay Sfernice

Power Resistor for Mounting onto a Heatsink Thick Film Technology



PERFORMANCE					
TESTS	CONDITIONS	REQUIREMENTS			
Momentary Overload	IEC 60115-1 $4 \times P_r/10 \text{ s}$ $U_{\text{max.}} \le U_{\text{L}} = 5000 \text{ V}$	± (0.25 % + 0.05 Ω)			
Rapid Temperature Change	IEC 60115-1/IEC 60068-2-14 Test Na 5 cycles - 55 °C to + 120 °C	± (0.5 % + 0.05 Ω)			
Load Life	IEC 60115-1 1000 h (90/30) P _r at 85 °C	± (0.5 % + 0.05 Ω)			
Humidity (Steady State)	IEC 60115-1 56 days RH 95 %/40 °C	± (0.5 % + 0.05 Ω)			
Vibration	MIL STD 202 Method 204 Cond. D (10 g; 5/500 Hz)	± (0.25 % + 0.05 Ω)			
Climatic Sequence	IEC 60115-1 (55/120/56)	± (1 % + 0.05 Ω)			

RECOMMENDATIONS FOR MOUNTING ONTO A HEATSINK

- · Surfaces in contact must be carefully cleaned.
- The heatsink must have an acceptable flatness: From 0.05 mm to 0.1 mm/100 mm.
- Roughness of the heatsink must be around 6.3 μm. In order to improve thermal conductivity, surfaces in contact (alumina, heatsink) should be coated with a silicone grease (type SI 340 from Rhône-Poulenc or Dow 340 from Dow Corning) or a thermal film (type Q Pad II) easier and faster to install than the grease.
- The fastening of the resistor to the heatsink is under pressure control of two screws tightened at 2 Nm for full power availability.

Tightening Torque on Heatsink	LPS 300	
	2 Nm	

• The following accessories are supplied with each product: 2 screws CHC M4 x 25 class 8.8 and 2 M4 contact lock washers for heatsink mounting.

2 screws TH M4 x 6/6 and 2 M4 contact lock washers for connections. 2 off CHC M4 x 16/16 class 8.

CHOICE OF THE HEATSINK

The user must choose the heatsink according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 120 °C. The dissipated power is simply calculated by the following ratio:

$$P = \frac{\Delta T}{[R_{TH (j-c)} + R_{TH (c-a)}]}$$

P: Expressed in W

ΔT: Difference between maximum working temperature and room temperature

R_{TH (j - c)}: Thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal

resistance of the component: (see specifications environmental paragraph).

R_{TH (c-a)}: Thermal resistance value measured between outer side of the resistor and room temperature. It is the thermal

resistance of the thermal interface, the heatsink (type, shape) and the quality of the fastening device.

Example:

 $R_{TH\ (c-a)}$ for LPS 300 power dissipation 180 W at + 50 °C room temperature.

$$\Delta T \le 120 \, ^{\circ}\text{C} - 50 \, ^{\circ}\text{C} = 70 \, ^{\circ}\text{C}$$

$$R_{TH~(j~c)} + R_{TH~(c~a)} = \frac{\Delta T}{P} = \frac{70}{180} = 0.388~^{\circ}C/W$$

 $R_{TH (j-c)} = 0.112 \, {}^{\circ}C/W$

 $R_{TH (c-a)} = 0.388 \, ^{\circ}\text{C/W} - 0.112 \, ^{\circ}\text{C/W} = 0.276 \, ^{\circ}\text{C/W}$

Document Number: 50052 Revision: 09-Jun-10



Power Resistor for Mounting onto a Heatsink Thick Film Technology

Vishay Sfernice

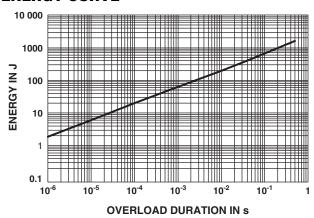
OVERLOADS

In any case the applied voltage must be lower than $U_{\rm L}$ = 5000 V.

Short time overload: $4 \times P_n/10 \text{ s}$

Accidental overload: The values indicated on the following graph are applicable to resistors in air or mounted onto a heatsink.

ENERGY CURVE



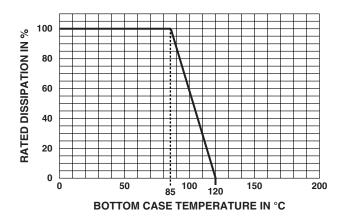
MARKING

Series, style, ohmic value (in Ω), tolerance (in %), manufacturing date, Vishay Sfernice trademark.

POWER RATING

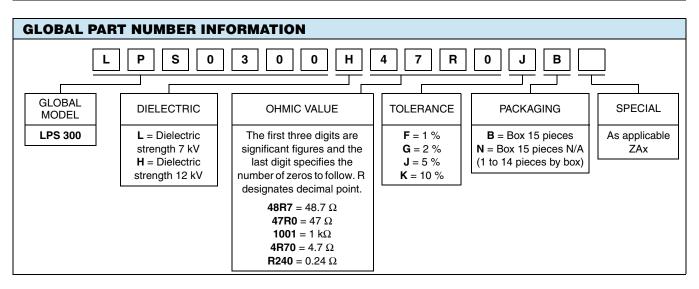
The temperature of the case should be maintained within the limits specified in the following figure.

To optimize the thermal conduction, contacting surfaces should be coated with silicone grease or thermal film, and heatsink mounting screws tightened to 2 Nm.



PACKAGING Box of 15 units

ORDERING INFORMATION						
LPS	300	100 k Ω	± 1 %	xxx	BO15	е
MODEL	STYLE	RESISTANCE VALUE	TOLERANCE	CUSTOM DESIGN	PACKAGING	LEAD (Pb)-FREE
			± 1 %	Optional		
			± 2 %	on request:		
			± 5 %	Special TCR,		
			± 10 %	shape etc.		





Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 Revision: 18-Jul-08

www.vishay.com